

04-05-2004



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If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

10/749,096

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Kimberly B. Downey

Internal Address:

Office of the General Counsel

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3701 North Fairfax Drive

City: Arlington

State: VA

ZIP: 22203

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PATENT
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CONFIRMATORY INSTRUMENT

Application for: "Multi-Layer Integrated Semiconductor Structure Having
an Electrical Shielding Portion"

Inventor(s): L Rafael Reif, Nisha Checka, and Anantha Chandrakasan

Serial Number: 10/749,096

Filing Date: December 30, 2003

Grant/Contract No.: Subcontract No. B-12-D00-S1, between G.I.T. and M.I.T., Effective
October 1, 1998, under Prime DARPA Grant No. MDA972-99-1-0002

Contractor: MASSACHUSETTS INSTITUTE OF TECHNOLOGY

M.I.T. Case No.: 10005

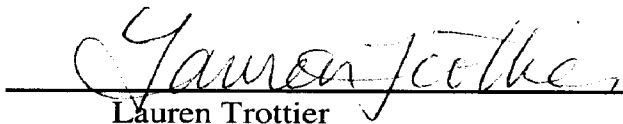
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Signed this 26th day of February, 2004.

MASSACHUSETTS INSTITUTE OF TECHNOLOGY

By



Lauren Trottier
Patent Compliance Administrator
Technology Licensing Office

77 Massachusetts Avenue, Room NE25-230, Cambridge, MA 02139

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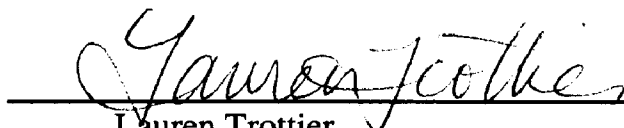
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